

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Packaging	Typical Dimension mm(inches)
1	IC1	1	—	TCK321G TCK322G TCK323G	TOSHIBA	Multiplexer load switch IC	WCSP16C	1.9 x 1.9
2	R1	1	10k Ω			63mW, \pm 5%	—	1.0 x 0.5 (0402)
3	C1	1	1 μ F			Ceramic, 50V, \pm 10%	—	3.2 x 1.6 (1206)
4	C2	1	1 μ F			Ceramic, 50V, \pm 10%	—	3.2 x 1.6 (1206)
5	C3	1	1 μ F			Ceramic, 50V, \pm 10%	—	3.2 x 1.6 (1206)

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